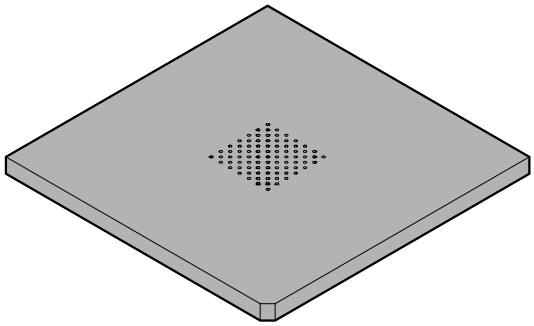
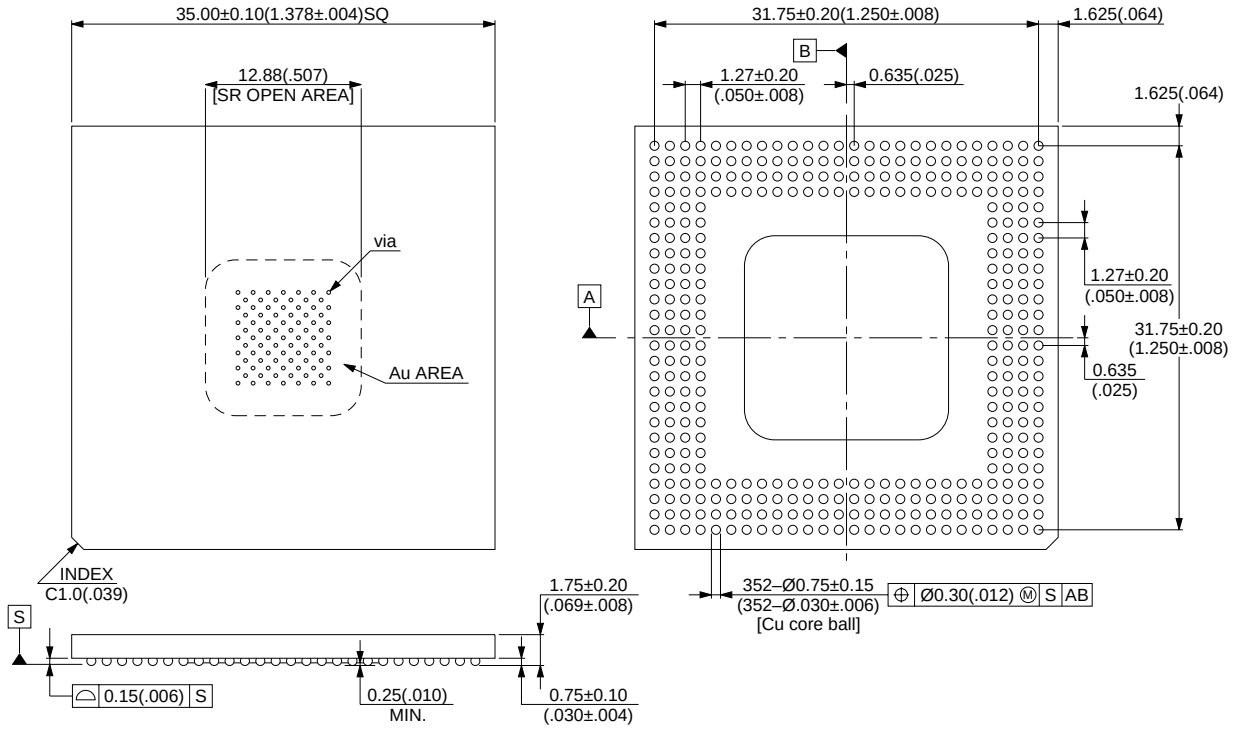
BALL GRID ARRAY PACKAGE
352 PIN PLASTIC

BGA-352P-M04

352-pin plastic BGA	Lead pitch	50 mil
	Pin matrix	26
	Sealing method	Resin seal
(BGA-352P-M04)		

352-pin plastic BGA
(BGA-352P-M04)



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Dimensions in mm (inches).

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